

Vishay Foil Resistors

Ultra High Precision Foil Wraparound Surface Mount Chip Resistor with TCR of ± 0.05 ppm/°C and Power Coefficient of 5 ppm at Rated Power



Any value at any tolerance within resistance range

INTRODUCTION

Top View

VSMP Series is the industry's first device to provide High Rated power, Excellent load life stability along with extremely low TCR all in one resistor.

One of the most important parameters influencing stability is the Temperature Coefficient of Resistance (TCR). Although the TCR of foil resistors is considered extremely low, this characteristic has been further refined over the years. The VSMP Series utilizes ultra high precision Bulk Metal® Z-Foil. The Z-Foil technology provides a significant reduction of the resistive element's sensitivity to ambient temperature variations (TCR) and to self heating when power is applied (power coefficient). Along with the inherently low PCR and TCR, Z-Foil technology also provides remarkably improved load life stability, low noise and availability of tight tolerance.

The VSMP has a full wraparound termination which ensures safe handling during the manufacturing process, as well as providing stability during multiple thermal cyclings.

Our Application Engineering Department is available to advise and make recommendations. For non-standard technical requirements and special applications, please contact us using the e-mail address in the footer below.

TABLE 1 - TOLERANCE AND TCR VS RESISTANCE VALUE¹⁾ (- 55 °C to + 125 °C + 25 °C Ref.)

(55 5 15 : 125 5, : 25 5 : 15)				
RESISTANCE VALUE (Ω)	TOLERANCE (%)	TYPICAL TCR AND MAX. SPREAD (ppm/°C)		
250 to 150K	± 0.01	± 0.2 ± 1.8		
100 to < 250	± 0.02	± 0.2 ± 1.8		
50 to < 100	± 0.05	± 0.2 ± 2.8		
25 to < 50	± 0.1	± 0.2 ± 3.8		
10 to < 25	± 0.25	± 0.2 ± 3.8		

Note

- 1. For tighter performances, please contact Vishay Application Engineering using the e-mail addresses in the footer below.
- * Pb containing terminations are not RoHS compliant, exemptions may apply

FEATURES

Temperature Coefficient of Resistance (TCR):
 0.05 ppm/°C typical (0 °C to + 60 °C)
 0.2 ppm/°C typical (- 55 °C to + 125 °C, + 25 °C Ref.)

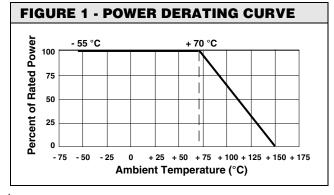


RoHS³

- Tolerance: to ± 0.01 %
- Power Coefficient "∆R due to self heating":
 5 ppm at Rated Power
- Power Rating: to 750 mW at + 70 °C
- Load Life Stability: to ± 0.005 % at 70 °C, 2000 hours at Rated Power
- Resistance Range: 10 Ω to 150 k Ω (for higher and lower values, please contact us)
- Electrostatic Discharge (ESD) above 25 000 Volts
- Short Time Overload: ≤ 0.005 %
- Non Inductive, Non Capacitive Design
- Rise Time: 1 ns without ringing
- Current Noise: 40 dB
- Voltage Coefficient < 0.1 ppm/V
- Non Inductive: < 0.08 μH
- Non Hot Spot Design
- Terminal Finishes Available: Lead (Pb)-free Tin/Lead Alloy
- · Matched sets are available on request
- Any value available within resistance range (e.g. 1K2345)
- Prototype samples available from 48 hours. For more information, please contact foil@vishay.com
- For better performances please contact us

APPLICATIONS

- Automatic Test Equipment (ATE)
- High Precision Instrumentation
- Laboratory, Industrial and Medical
- Audic
- EB Applications (electron beam scanning and recording equipment, electron microscopes)
- · Military and Space
- Airborne
- Down Hole instrumentation
- Communication



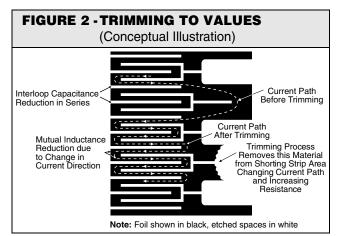
VSMP Series (0805, 1206, 1506, 2010, 2512) (Z-Foil)

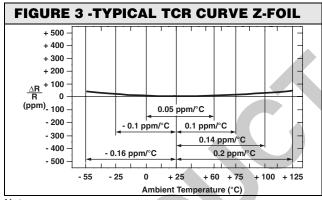


Vishay Foil Resistors Ultra High Precision Foil Wraparound Surface

Mount Chip Resistor with TCR of ± 0.05 ppm/°C

and Power Coefficient of 5 ppm at Rated Power





Note

TABLE 2 - DIMENSIONS AND LAND PATTERN in inches (millimeters) **Bottom View for Mounting Recommended Land Pattern** Uncoated Ceramic **Footprint** Т ⁄ ח` THICKNESS CHIP $\pm 0.00\overline{5} (0.13)$ ± 0.005 (0.13) $\pm 0.005 (0.13)$ MAXIMUM MINIMUM **MAXIMUM MAXIMUM** SIZE 0805 0.080 (2.03) 0.050 (1.27) 0.025 (0.64) 0.015 (0.38) 0.122 (3.10) 0.028 (0.71) 0.050 (1.27) 0.020 (0.51) 0.059 (1.50) 0.071 (1.80) 1206 0.126 (3.20) 0.062 (1.57) 0.025 (0.64) 0.175 (4.45) 0.083 (2.11) 1506 0.150 (3.81) 0.062 (1.57) 0.025 (0.64) 0.020 (0.51) 0.199 (5.05) 0.071 (1.80) 0.025 (0.64) 2010 0.198 (5.03) 0.097 (2.46) 0.025 (0.64) 0.247 (6.27) 0.115 (2.92) 0.103 (2.62) 0.249 (6.32) 0.025 (0.64) 2512 0.127 (3.23) 0.032 (0.81) 0.291 (7.39) 0.150 (3.81) 0.127 (3.23)

Note

^{1.} Land Pattern Dimensions are per IPC-782

TABLE 3 - SPECIFICATIONS					
CHIP SIZE	RATED POWER (mW) at + 70 °C	$\begin{array}{c} MAX \\ VOLTAGE \\ RATING \\ (\leq \sqrt{P \times R}) \end{array}$	$\begin{array}{c} \textbf{RESISTANCE} \\ \textbf{RANGE} \\ (\Omega) \end{array}$	MAXIMUM WEIGHT (mg)	
0805	200	49 V	10 to 12K	6	
1206	300	95 V	10 to 30K	11	
1506	300	110 V	10 to 40K	12	
2010	500	200 V	10 to 100K	27	
2512	750	220 V	10 to 150K	40	

TABLE 4 - LOAD LIFE STABILITY (+ 70 °C for 2000 hours)			
CHIP SIZE	MAXIMUM ∆R LIMITS		
0805	± 0.005 % at 100 mW ± 0.01 % at 200 mW		
1206, 1506	± 0.005 % at 150 mW ± 0.01 % at 300 mW		
2010	± 0.005 % at 200 mW ± 0.01 % at 500 mW		
2512	± 0.005 % at 500 mW ± 0.01 % at 750 mW		

TABLE 5 - PERFORMANCES			
TEST OR CONDITIONS	MIL-PRF-55342 CHARACTERISTIC E ∆R LIMITS	TYPICAL AR LIMITS	MAXIMUM ∆R LIMITS¹)
Thermal Shock	± 0.1 %	± 0.005 % (50 ppm)	± 0.01 % (100 ppm)
Low Temperature Operation	± 0.1 %	± 0.005 % (50 ppm)	± 0.01 % (100 ppm)
Short Time Overload	± 0.1 %	± 0.005 % (50 ppm)	± 0.01 % (100 ppm)
High Temperature Exposure	± 0.1 %	± 0.01 % (100 ppm)	± 0.02 % (200 ppm)
Resistance to Soldering Heat	± 0.2 %	± 0.005 % (50 ppm)	± 0.01 % (100 ppm)
Moisture Resistance	± 0.2 %	± 0.005 % (50 ppm)	± 0.02 % (200 ppm)
Load Life Stability + 70 °C for 2000 hours at Rated Power	± 0.5 %	± 0.005 % (50 ppm)	± 0.01 % (100 ppm)

Note

[•] The TCR values for $< 100~\Omega$ are influenced by the termination composition and result in deviation from this curve.

^{1.} As shown + 0.01 Ω to allow for measurement errors at low values.



VSMP Series (0805, 1206, 1506, 2010, 2512) (Z-Foil)

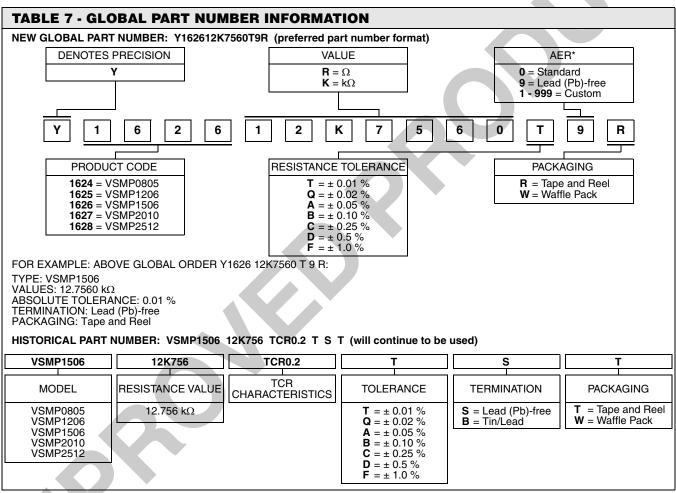
Ultra High Precision Foil Wraparound Surface Vishay Foil Resistors Mount Chip Resistor with TCR of ± 0.05 ppm/°C and Power Coefficient of 5 ppm at Rated Power

FIGURE 4 - RECOMMENDED MOUNTING 25 % to 85 % of T A low profile solder fillet is recommended to avoid unnecessary stresses along top edge of metallization. IR and vapor phase reflow are best. Avoid the use of cleaning agents which could attack epoxy resins, which form part of the resistor construction.

TABLE 6 - DSCC SPECIFICATIONS Vishay resistors are listed on the following DSCC specifications				
MODEL	DSCC	MIL SPEC		
VSMP1506	03010	MIL-PRF-55342		
VSMP2010	06001	MIL-PRF-55342		
VSMP2512	06002	MIL-PRF-55342		

Note

 For VSMP0805 and VSMP1206 DSCC drawings, please contact foil@vishay.com



Note

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^{*} For non-standard requests, please contact Application Engineering.

Legal Disclaimer Notice



Vishay

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